Constant Impedance K$_{|Z|}$ *SP2T RF Switch*   *300 kHz to 8000 MHz*

GENERAL DESCRIPTION

The F2923 is a low insertion loss 50Ω SP2T absorptive RF Switch designed for a multitude of wireless and other RF applications. This device covers a broad frequency range from 300 kHz to 8000 MHz. In addition to providing low insertion loss, industry leading isolation at 2 GHz and excellent linearity, the F2923 also includes a patent pending constant impedance (K$_Z$) feature. K$_Z$ minimizes LO pulling in VCOs and reduces phase and amplitude variations in distribution networks. It is also ideal for dynamic switching/selection between two or more amplifiers while avoiding damage to upstream/downstream sensitive devices such as PAs and ADCs.

The F2923 uses a single positive supply voltage of 3.3 V supporting three states using either 3.3 V or 1.8 V control logic. An added feature includes a ModeCTL pin allowing the user to control the device with either 1-pin or 2-pin control.

COMPETITIVE ADVANTAGE

The F2923 provides constant impedance on all ports during transitions without compromising isolation, linearity, or insertion loss.

- ✓ Constant impedance K$_{|Z|}$ during switching transition
- ✓ VSWR RF_Com port 1.4:1 vs. 9:1 for Standard Switch
- ✓ Insertion Loss = 0.48 dB*
- ✓ IIP3: +66 dBm*
- ✓ RF1/RF2 to RF_COM Isolation = 74 dB*
- ✓ Extended temperature: -55 °C to +105 °C
- ✓ Negative supply voltage not required
 *2 GHz

APPLICATIONS

- Base Station 2G, 3G, 4G
- Portable Wireless
- Repeaters and E911 systems
- Digital Pre-Distortion
- Point to Point Infrastructure
- Public Safety Infrastructure
- WIMAX Receivers and Transmitters
- Military Systems, JTRS radios
- RFID handheld and portable readers
- Cable Infrastructure
- Wireless LAN
- Test / ATE Equipment

FEATURES

- Constant Impedance K$_{|Z|}$ during transition
- Very low insertion loss: 0.48 dB @ 2 GHz
- High Input IP3: 66 dB @ 2 GHz
- RF1/RF2 to RF_Com Isolation: 74 dB @ 2 GHz
- 1-pin or 2-pin device control option
- Low DC current: 127 µA using 3.3 V logic
- Supply voltage: 3.3 V
- Supports 1.8 V and 3.3 V control logic
- Extended temperature: -55 °C to +105 °C
- 4 mm x 4 mm, 20-pin TQFN package
- Pin compatible with F2912

FUNCTIONAL BLOCK DIAGRAM
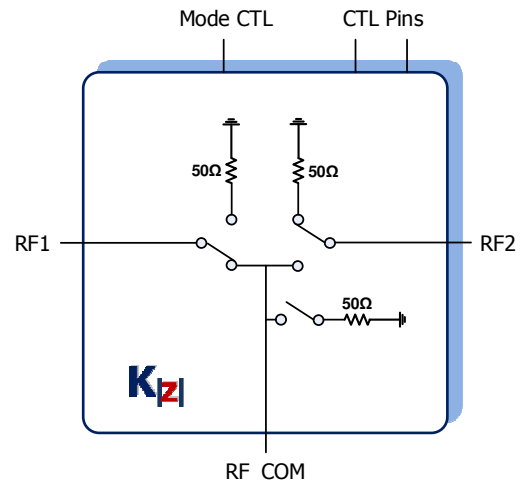
ORDERING INFORMATION

ABSOLUTE MAXIMUM RATINGS

Parameter / Condition	Symbol	Min	Max	Unit
Vcc to GND	V_{CC}	-0.3	+3.9	V
CTL1, CTL2	V_{CNTL}	-0.3	Vcc + 0.3	V
ModeCTL to GND	V_{MODE}	-0.3	Vcc + 0.3	V
RF1, RF2, RF_COM	V_{RF}	-0.3	+0.3	V
Maximum Junction Temperature	T_{Jmax}		+140	°C
Storage Temperature Range	T_{ST}	-65	+150	°C
Lead Temperature (soldering, 10s)	T_{LEAD}		+260	°C
ESD Voltage– HBM (Per JESD22-A114)	V_{ESDHBM}		Class 2	
ESD Voltage – CDM (Per JESD22-C101)	V_{ESDCDM}		Class III	

ABS MAX RF POWER AT 2 GHZ WITH TC = +85 °C *
RF1, RF2, RF_COM (RF1 or RF2 is connected to RF_COM, IL States) +33dBm
RF1, RF2, RF_COM (When port is internally terminated) +24dBm

ABS MAX RF POWER AT 2 GHZ WITH TC = +105 °C *
RF1, RF2, RF_COM (RF1 or RF2 is connected to RF_COM, IL States) +33dBm
RF1, RF2, RF_COM (When port is internally terminated) +21dBm

* Temperature of exposed paddle

Stresses above those listed above may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL AND MOISTURE CHARACTERISTICS

θ_{JA} (Junction – Ambient) 60 °C/W
θ_{JC} (Junction – Case) The Case is defined as the exposed paddle 3.9 °C/W
Moisture Sensitivity Rating (Per J-STD-020) MSL1

F2923 RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CC}		3.1		3.5	V
Operating Temperature Range	T_{CASE}	Case Temperature	-55		+105	^{O}C
RF Frequency Range	F_{RF}		0.3		8000	MHz
RF Continuous Input Power (CW) [1]	P_{RF}	Selected Port (I.L. State)			27	dBm
		Unselected Port[2] (Term State)			18	
RF1 Port Impedance	Z_{RF1}			50		Ω
RF2 Port Impedance	Z_{RF2}			50		
RF_COM Port Impedance	Z_{RF_COM}			50		

Note 1– See Figure 1 below for RF power handling levels for various conditions.
Note 2– States 1, 2, or 3.
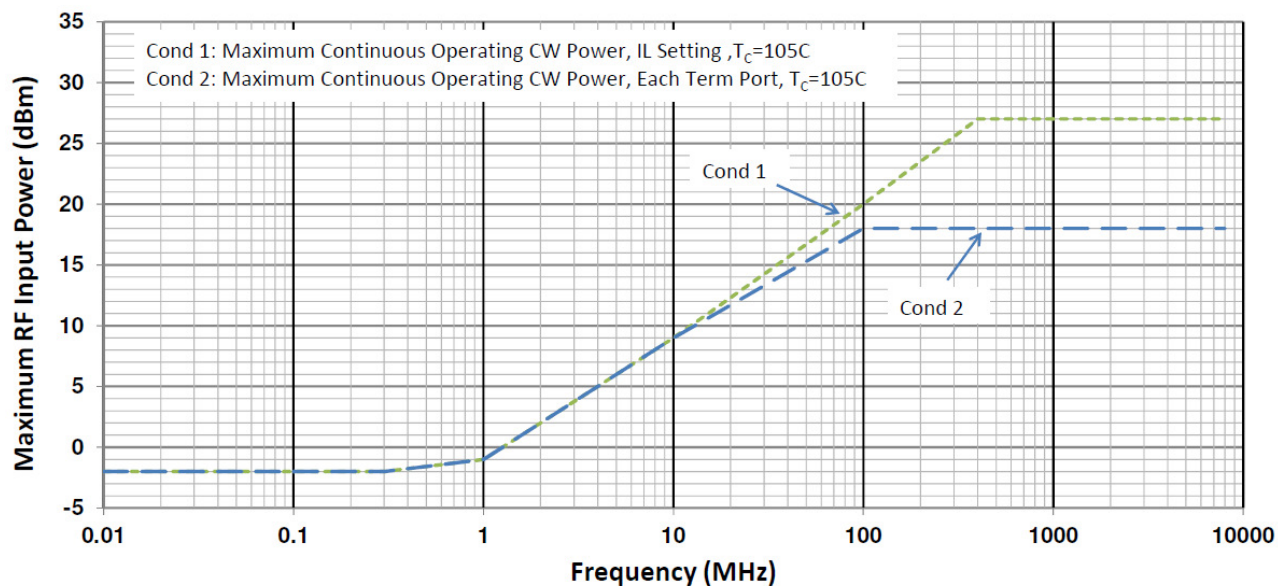
FIGURE 1: MAXIMUM OPERATING RF INPUT POWER VS. RF FREQUENCY

F2923 SPECIFICATION

Typical Application Circuit, V_{CC} = +3.3 V, T_C = +25 °C, F_{RF} = 2 GHz, input power = 0 dBm unless otherwise stated. PCB board trace and connector losses are de-embedded unless otherwise noted.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Logic Input High Threshold	V_{IH}	CTL1 and CTL2 pins	*1.1*		*3.6*	V
Logic Input Low Threshold	V_{IL}	CTL1 and CTL2 pins			*0.6*	V
ModeCTL Input High				Vcc		V
ModeCTL Input Low				GND		V
Logic Current	I_{IH}, I_{IL}	CTL1, CTL2, ModeCTL pins			*1000*	nA
DC Current (Vcc)	I_{CC}	State 2 or State 3		127	*150*	µA
VSWR during transition	$VSWR_T$	RF1/RF2 to RF_COM		1.4:1		-
Insertion Loss RF1/RF2 to RF_COM (State 2 or 3)	IL	RF = 1 GHz		0.43		dB
		RF = 2 GHz		0.48	*0.8[1]*	
		RF = 4 GHz		0.63		
		RF = 6 GHz		0.89		
		RF = 8 GHz		1.12		
Isolation RF1 / RF2 to RF_COM (State 2 or 3)	ISO1	RF = 1 GHz		77		dB
		RF = 2 GHz	71[2]	74		
		RF = 4 GHz		51		
		RF = 6 GHz		40		
		RF = 8 GHz		37		
Isolation RF1 to RF2 (State 2 or 3)	ISO2	RF = 1 GHz		73		dB
		RF = 2 GHz	61	63		
		RF = 4 GHz		51		
		RF = 6 GHz		35		
		RF = 8 GHz		29		
Return Loss RF_COM (State 1)	RL1	RF = 1 GHz		23.8		dB
		RF = 2 GHz		25.2		
		RF = 4 GHz		26.7		
		RF = 6 GHz		18.4		
		RF = 8 GHz		16.6		
Return Loss RF_COM (State 2 or 3)	RL2	RF = 1 GHz		29.6		dB
		RF = 2 GHz		25.4		
		RF = 4 GHz		26.1		
		RF = 6 GHz		17.6		
		RF = 8 GHz		14.1		

Note 1– Items in min/max columns in ***bold italics*** are Guaranteed by Test.
Note 2– Items in min/max columns NOT in bold italics are Guaranteed by Design Characterization.

F2923 SPECIFICATION (CONT.)

Typical Application Circuit, V_{CC} = +3.3 V, T_C = +25 °C, F_{RF} = 2 GHz, input power = 0 dBm unless otherwise stated. PCB board trace and connector losses are de-embedded unless otherwise noted.

Parameter	Symbol	Conditions		Min	Typ	Max	Units
Return Loss RF1, RF2 (State 1)	RL3	RF = 1 GHz			22.6		dB
		RF = 2 GHz			23.4		
		RF = 4 GHz			25.2		
		RF = 6 GHz			19.9		
		RF = 8 GHz			11.2		
Return Loss RF1, RF2 when selected (State 2 or 3)	RL4	RF = 1 GHz			33.7		dB
		RF = 2 GHz			28.4		
		RF = 4 GHz			28.0		
		RF = 6 GHz			17.7		
		RF = 8 GHz			15.0		
Input IP2 RF1 / RF2 (State 2 or 3)	IIP2	P_{IN}= +13 dBm per tone	RF = 1 GHz		116		dBm
			RF = 2 GHz		106		
			RF = 3 GHz		105		
Input IP3 RF1 / RF2 (State 2 or 3)	IIP3	P_{IN} =+13 dBm per tone	RF = 1 GHz		66		dBm
			RF = 2 GHz		66		
			RF = 3 GHz		65		
			RF = 4 GHz		65		
			RF = 6 GHz		52		
Input 1dB compression RF1 / RF2 (State 2 or 3) [3]	IP1dB	RF = 2 GHz			32		dBm
Switching Time [4]	T_{SW}	50% control to 90% RF			0.6		µs
		50% control to 10% RF			0.5		
		50% control to RF settled to within +/- 0.1 dB of I.L. value.			0.675		
Maximum Switching Rate	SW_{RATE}				25		kHz
Maximum spurious level on any RF port [5]	$Spur_{MAX}$	RF ports terminated into 50Ω			-137		dBm

Note 1– Items in min/max columns in **bold italics** are Guaranteed by Test.
Note 2– Items in min/max columns NOT in bold italics are Guaranteed by Design Characterization.
Note 3– The input 1dB compression point is a linearity figure of merit. Refer to Figure 1 above and
         Recommended Operating Conditions sections for the maximum RF input powers.
Note 4– F_{RF} = 2 GHz.
Note 5– Spurious due to on-chip negative voltage generator. Typical generator fundamental frequency is 2.2 MHz.

Table 1 includes 3 states and provides the truth table for 2-pin control input.

Table 1 - Switch Control Truth Table for 3 states using 2 control pins; pin 16 and pin 17

State	Control pin input		RF1, RF2 input / output	
	CTL1 (Pin 17)	CTL2 (Pin 16)	RF1 to RF Com	RF2 to RF Com
1	Low	Low	OFF	OFF
2	Low	High	OFF	ON
3	High	Low	ON	OFF
4	High	High	N/A	N/A

Table 2 includes 2 states and provides the truth table for 1-pin control input.

Table 2 - Switch Control Truth Table for 2 states using a single control pin 16

State	Control pin input		RF1, RF2 input / output	
	CTL1 (Pin 17)	CTL2 (Pin 16)	RF1 to RF Com	RF2 to RF Com
2	don't care	High	OFF	ON
3	don't care	Low	ON	OFF

Table 3 provides the truth table for selecting the use of either 1 or 2 control pins.

Table 3 - Mode Control (pin 19) Truth table to use either 1 or 2 control pins

Pin Control Mode	ModeCTL (Pin 19)
2-pin control: CTL1 and CTL2	GND
1-pin control: CTL2	VCC

Notes:
1. When RF1 and RF2 ports are both open (State 1), all 3 RF ports are terminated to an internal 50 Ω termination resistor.
2. When RF1 or RF2 port is open (State 2 or State 3 OFF condition), the open port is connected to an internal 50Ω termination resistor.
3. When RF1 or RF2 port is closed (State 2 or State 3 ON condition), the closed port is connected to the RF_COM port.

TYPICAL OPERATING CURVE CONDITIONS

Unless otherwise noted, the following conditions apply:

- EVKit loss de-embedded for only insertion loss plots.
- V_{CC} = 3.3 V
- F_{RF} = 2 GHz
- T_{AMB} = 25 ^{O}C
- Small signal parameters measured with P_{IN} = 0dBm.
- Two tone tests P_{IN} =+13 dBm/tone with 50 MHz tone spacing.

TYPICAL OPERATING CONDITIONS (- 1 -)

Insertion Loss vs. Temperature
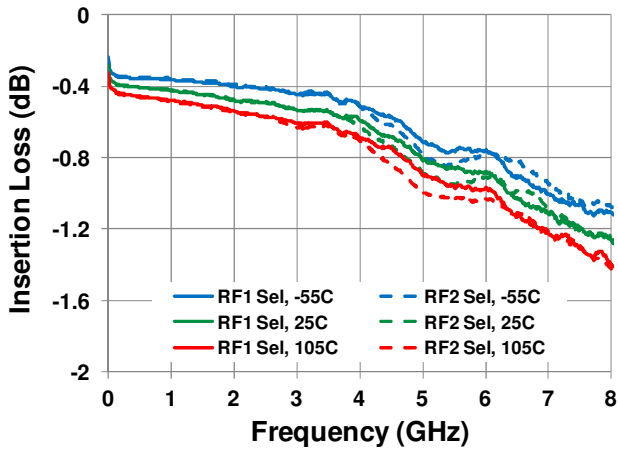
Insertion Loss vs. Voltage
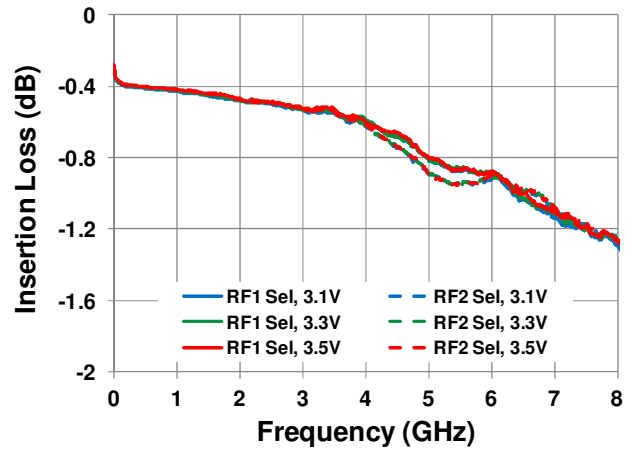
Isolation vs. Temp [RF_COM → RF1 / RF2]
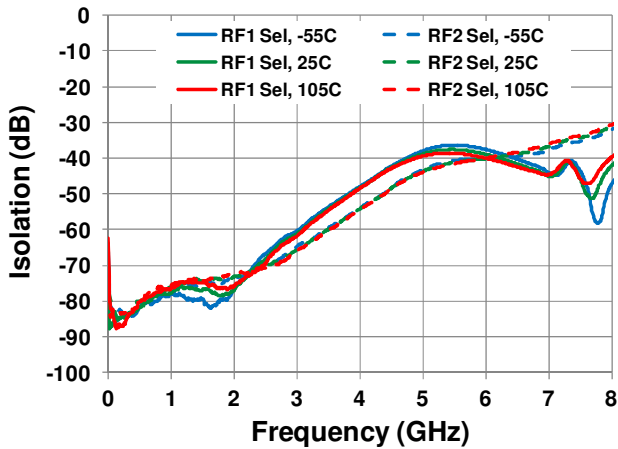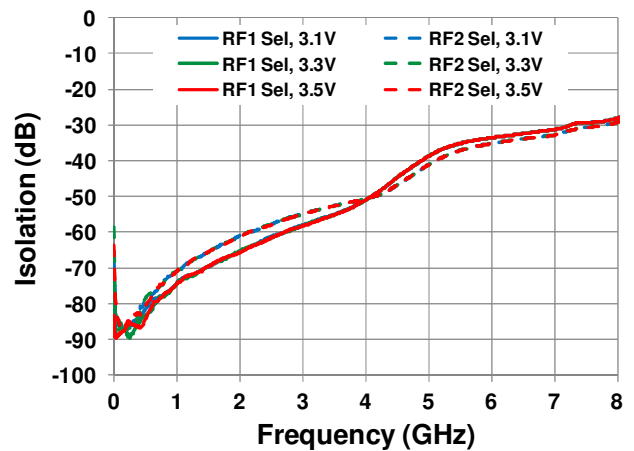

Isolation vs. Voltage [RF_COM → RF1 / RF2]
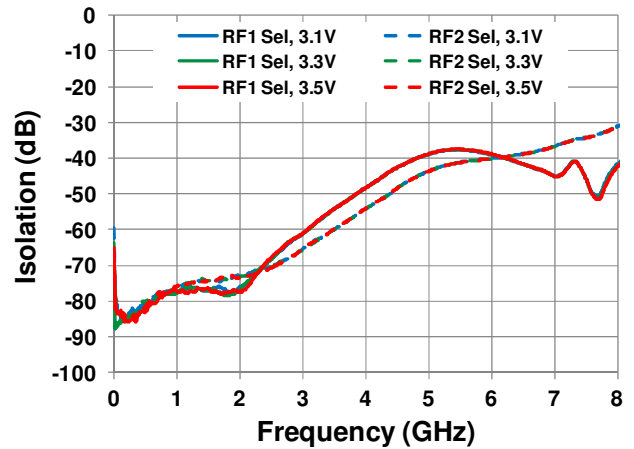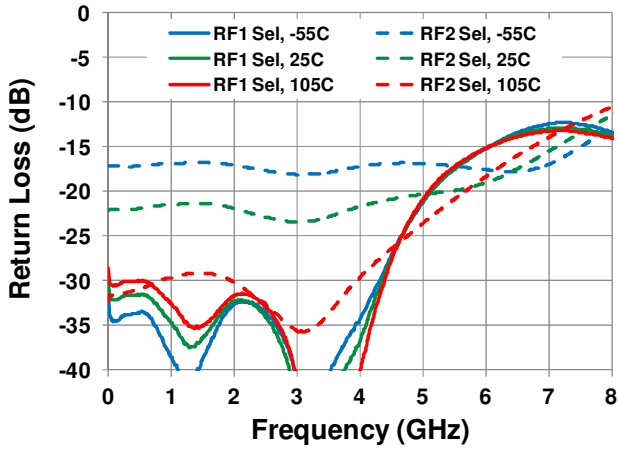

Isolation vs. Temp [RF1 → RF2, RF2 → RF1]
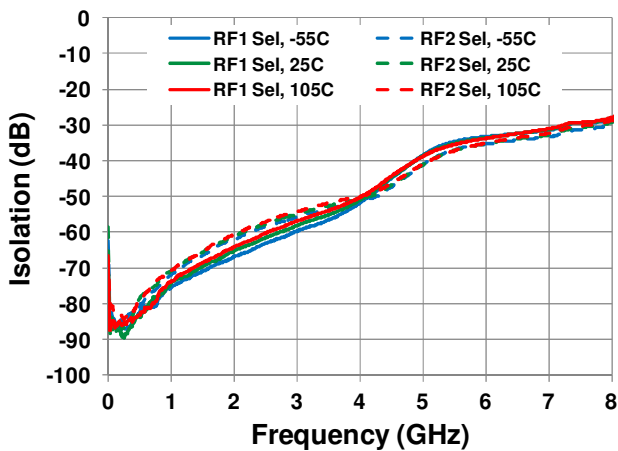
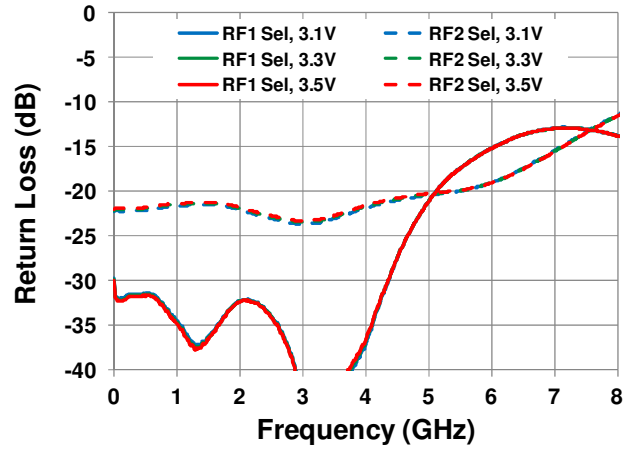## Isolation vs. Voltage [RF1 → RF2, RF2 → RF1]
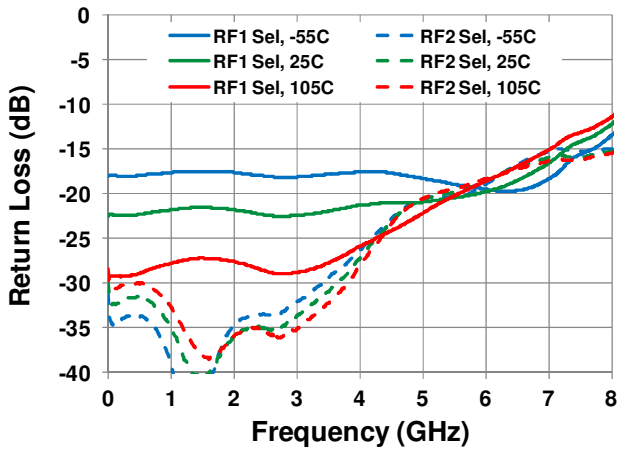
TYPICAL OPERATING CONDITIONS (- 2 -)

RF1 Return Loss vs. Temperature

RF1 Return Loss vs. Voltage

RF2 Return Loss vs. Temperature

RF2 Return Loss vs. Voltage
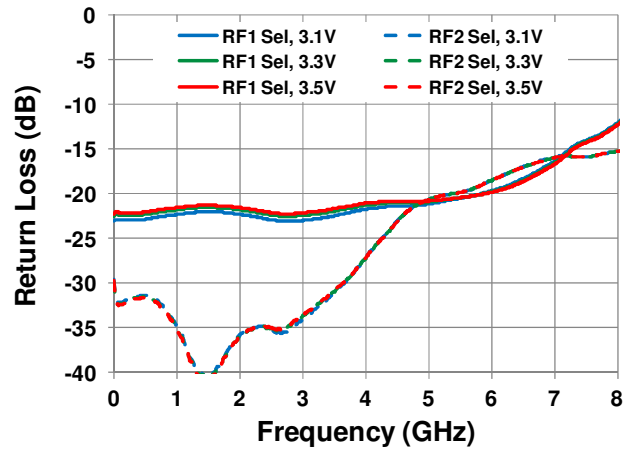
RF_COM Return Loss vs. Temperature
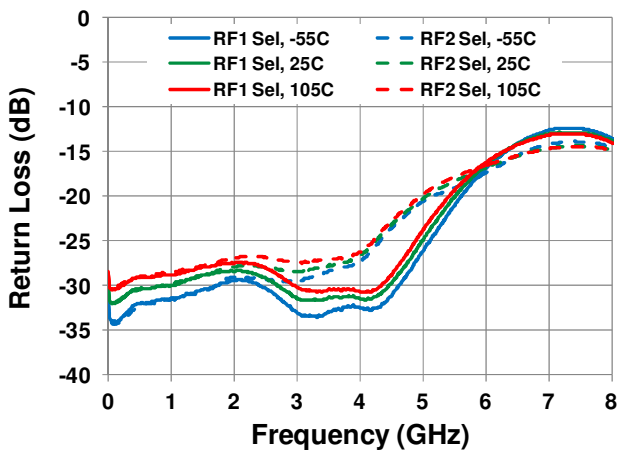
RF_COM Return Loss vs. Voltage
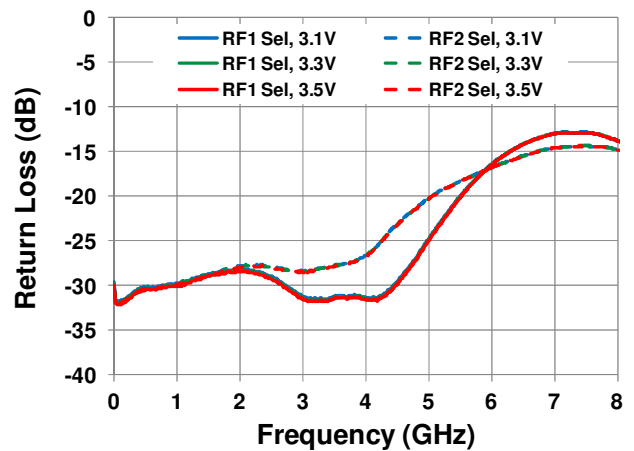
TYPICAL OPERATING CONDITIONS (- 3 -)

Isolation vs. Temp [All Off State, RF_COM Driven]

Legend:
- RF1 Out, -55C
- RF2 Out, -55C
- RF1 Out, 25C
- RF2 Out, 25C
- RF1 Out, 105C
- RF2 Out, 105C

X-axis: Frequency (GHz), Y-axis: Isolation (dB)
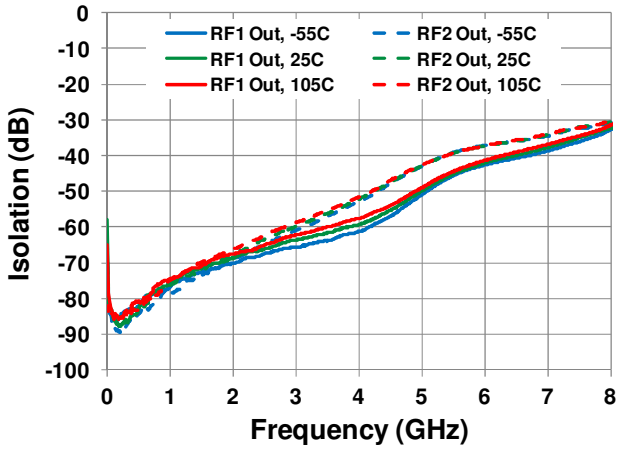
Isolation vs. Voltage [All Off State, RF_COM Driven]

Legend:
- RF1 Out, 3.1V
- RF2 Out, 3.1V
- RF1 Out, 3.3V
- RF2 Out, 3.3V
- RF1 Out, 3.5V
- RF2 Out, 3.5V

X-axis: Frequency (GHz), Y-axis: Isolation (dB)

RF_COM Return Loss [All Off State] vs. Temp

Legend:
- -55C
- 25C
- 105C

X-axis: Frequency (GHz), Y-axis: Return Loss (dB)
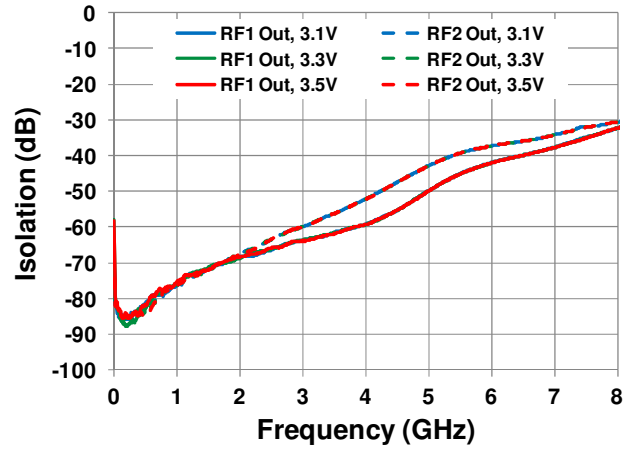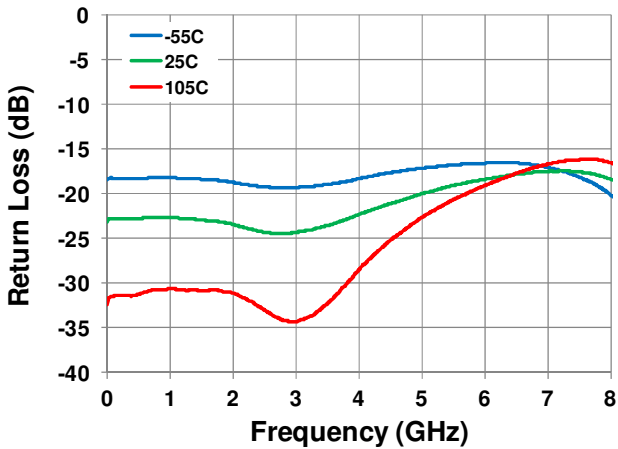
RF_COM Return Loss [All Off State] vs. Voltage

Legend:
- 3.1V
- 3.3V
- 3.5V

X-axis: Frequency (GHz), Y-axis: Return Loss (dB)
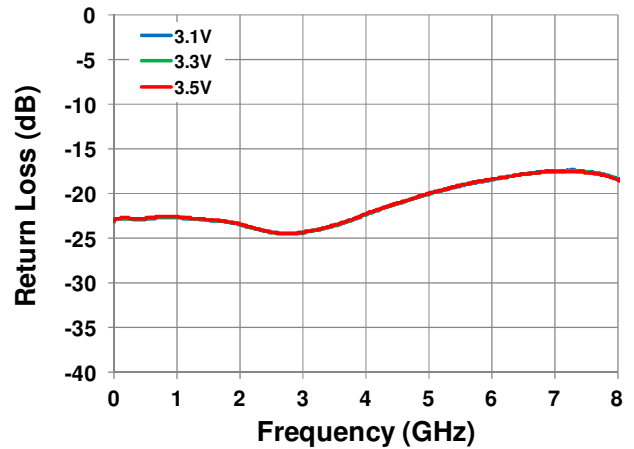
Return Loss (During Switching) vs. Time

Legend:
- RF1 (RF1 Term to RFCOM) or RF2 (RF2 Term to RFCOM)
- RF1 (RFCOM to RF1 Term) or RF2 (RFCOM to RF2 Term)
- RFCOM (RF1 to RF2) or RFCOM (RF2 to RF1)

50% CTRL at t= t_0

X-axis: Time (μsec), Y-axis: Return Loss (dB)

VSWR (During Switching) vs. Time

Legend:
- RF1 (RF1 Term to RFCOM) or RF2 (RF2 Term to RFCOM)
- RF1 (RFCOM to RF1 Term) or RF2 (RFCOM to RF2 Term)
- RFCOM (RF1 to RF2) or RFCOM (RF2 to RF1)

50% CTRL at t= t_0

X-axis: Time (μsec), Y-axis: VSWR
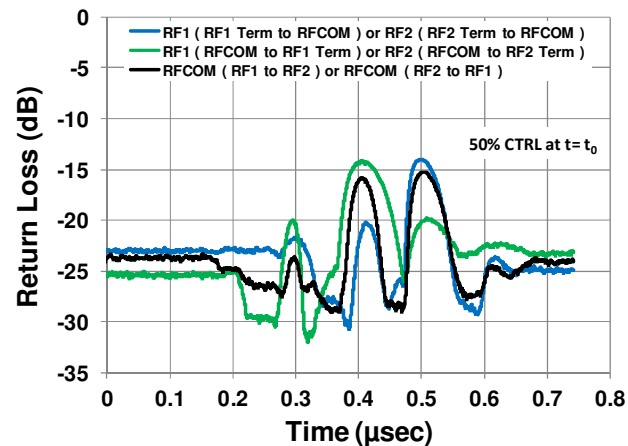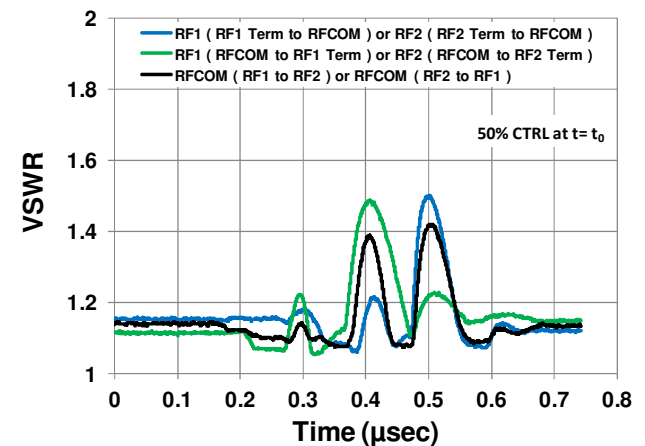
TYPICAL OPERATING CONDITIONS (- 4 -)

Switching Time Tc=25C [RF_COM Driven, RF1 to RF2]
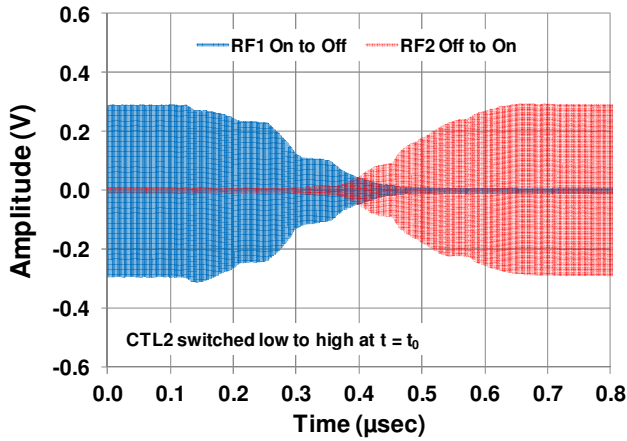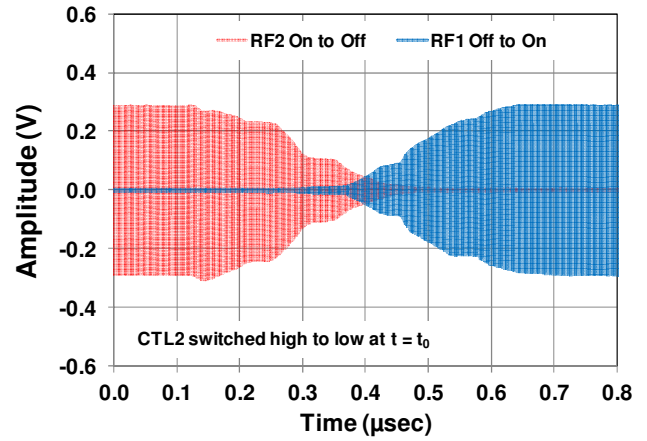
RF1 On to Off   RF2 Off to On

CTL2 switched low to high at t = t0

Switching Time Tc=25C [RF_COM Driven, RF2 to RF1]

RF2 On to Off   RF1 Off to On

CTL2 switched high to low at t = t0

Switching Time Tc=-40C [RF_COM Driven, RF1 to RF2]

RF1 On to Off   RF2 On to Off

CTL2 switched low to high at t = t0

Switching Time Tc=-40C [RF_COM Driven, RF2 to RF1]

RF2 On to Off   RF1 Off to On

CTL2 switched high to low at t = t0
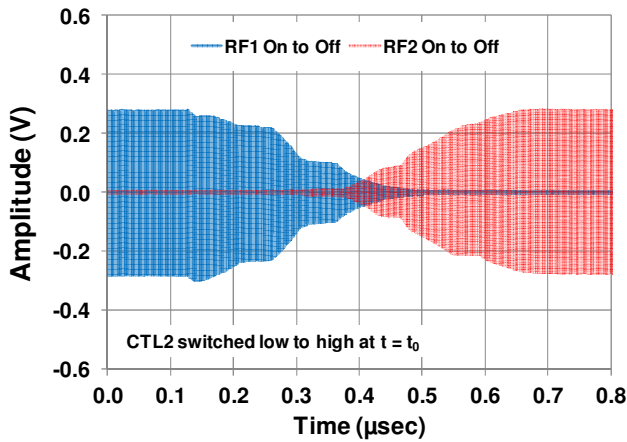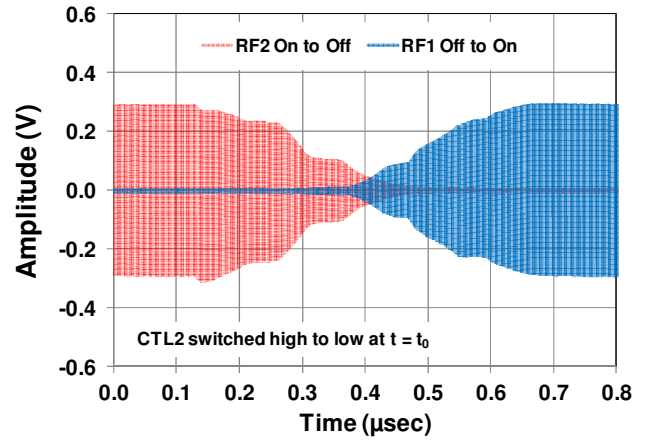
Compression [1 GHz, 2 GHz, RF1, RF2]

RF1, 1GHz   RF2, 1GHz
RF1, 2GHz   RF2, 2GHz

Input IP3 [1 GHz]

-55C / RF1   25C / RF1   105C / RF1
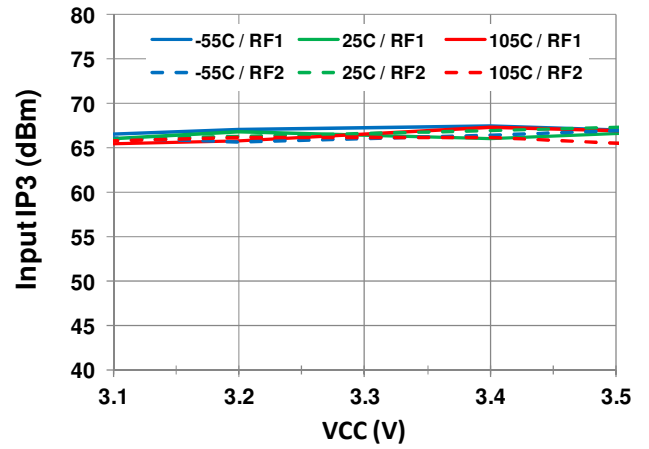-55C / RF2   25C / RF2   105C / RF2
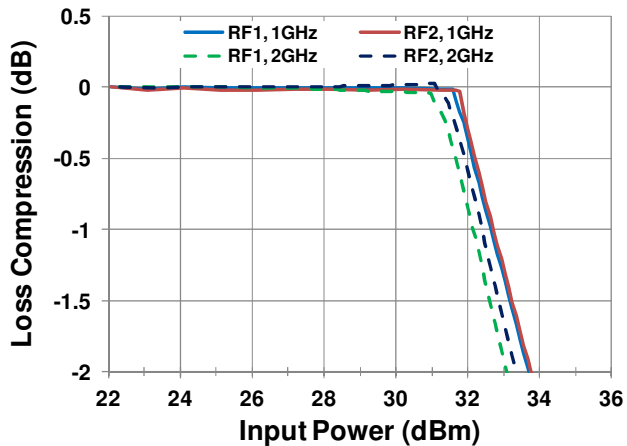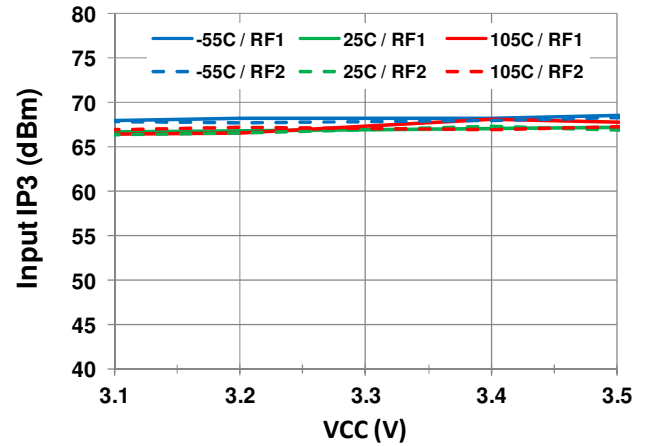
TYPICAL OPERATING CONDITIONS (- 5 -)
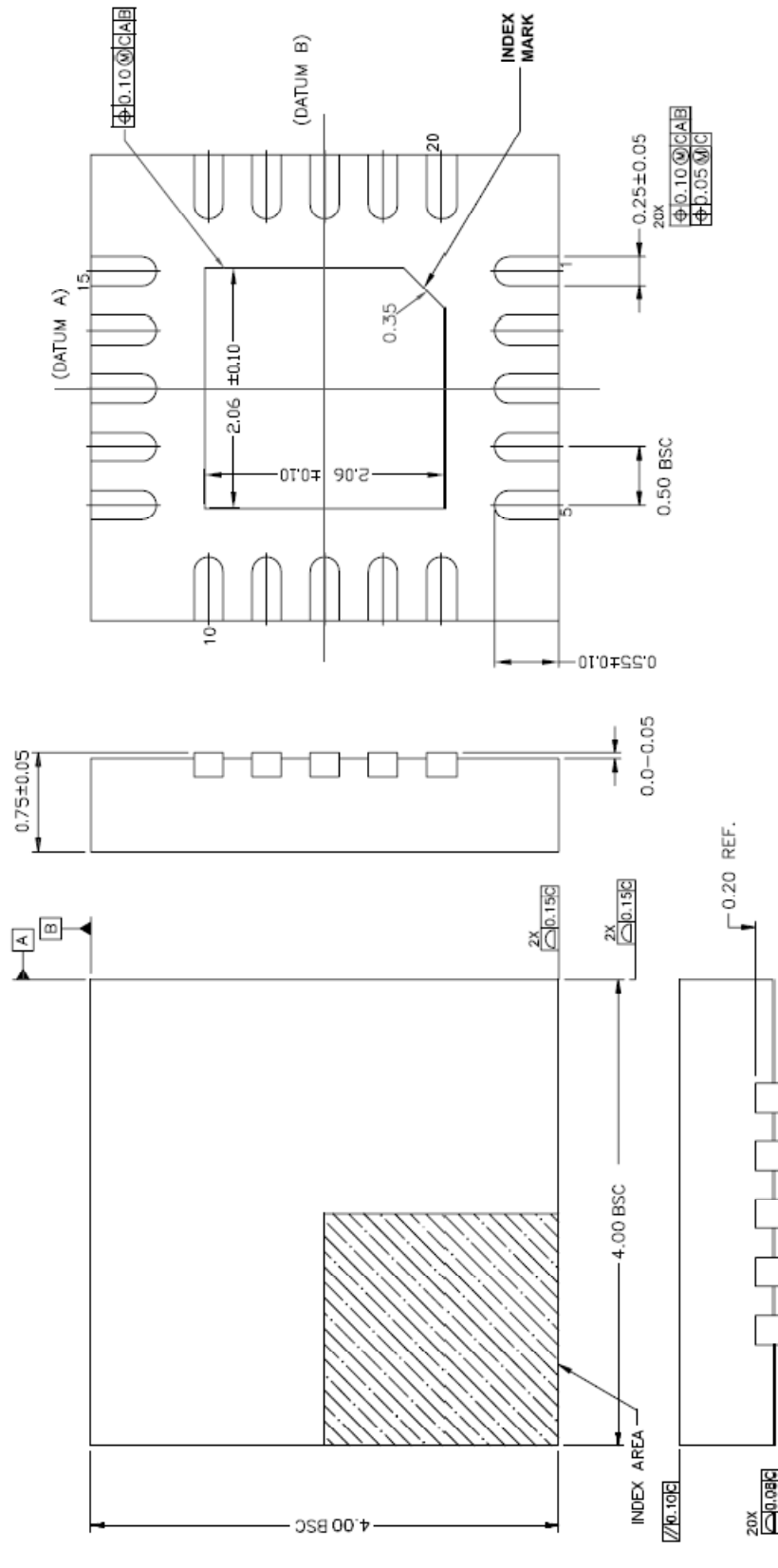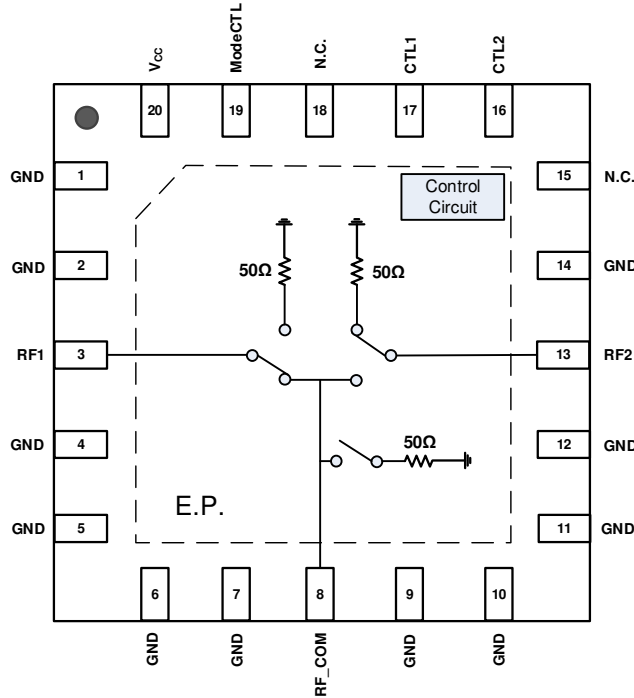
Input IP3 [2 GHz]
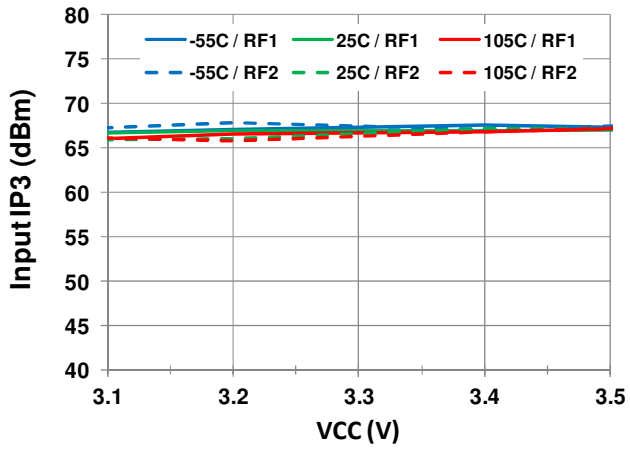
Input IP3 [3 GHz]

PACKAGE DRAWING

(4 mm x 4 mm 20-pin TQFN), NCG20

NOTE :
1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
   COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. REFER JEDEC MO-220.

LAND PATTERN DIMENSION

RECOMMENDED LAND PATTERN DIMENSION

NOTES:
1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT
   FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

PIN DIAGRAM

PIN DESCRIPTION

Pin	Name	Function
1, 2, 4, 5, 6, 7, 9, 10, 11, 12, 14	GND	Ground these pins.
3	RF1	RF1 Port. Matched to 50Ω. If this pin is not 0V DC, then an external coupling capacitor must be used.
8	RF_COM	RF Common Port. Matched to 50Ω. If this pin is not 0V DC, then an external coupling capacitor must be used.
13	RF2	RF2 Port. Matched to 50Ω. If this pin is not 0V DC, then an external coupling capacitor must be used.
15	N.C.	No internal connection. This pin can be left open or connected to ground.
16	CTL2	Control 2 – See Table 1 and Table 2 Switch Control Truth Tables for proper logic setting.
17	CTL1	Control 1 – See Table 1 and Table 2 Switch Control Truth Tables for proper logic setting.
18	N.C.	No internal connection.
19	ModeCTL	Mode Control – See Table 3 Mode Control Truth Table. Apply VCC to select 1-pin control or GND for 2-pin control.
20	Vcc	Power Supply. Bypass to GND with capacitors shown in the Typical Application Circuit as close as possible to pin.
21	— EP	Exposed Pad. Internally connected to GND. Solder this exposed pad to a PCB pad that uses multiple ground vias to provide heat transfer out of the device into the PCB ground planes. These multiple ground vias are also required to achieve the specified RF performance.

## APPLICATIONS INFORMATION

Default Start-up

Control pins include no internal pull-down resistors to logic LOW or pull-up resistors to logic HIGH. Upon start-up, all control pins should be set to logic LOW (0) thereby enabling 2-pin switch control, opening both RF1 and RF2 paths, and setting logic control voltage to 3.3 V (see above tables for LOW logic states).

Power Supplies

A common VCC power supply should be used for all pins requiring DC power. All supply pins should be bypassed with external capacitors to minimize noise and fast transients. Supply noise can degrade noise figure and fast transients can trigger ESD clamps and cause them to fail. Supply voltage change or transients should have a slew rate smaller than 1 V / 20 µS. In addition, all control pins should remain at 0 V (+/-0.3 V) while the supply voltage ramps or while it returns to zero.

Control Pin Interface

If control signal integrity is a concern and clean signals cannot be guaranteed due to overshoot, undershoot, ringing, etc., the following circuit at the input of each control pin is recommended. This applies to control pins 16, 17, and 19 as shown below.
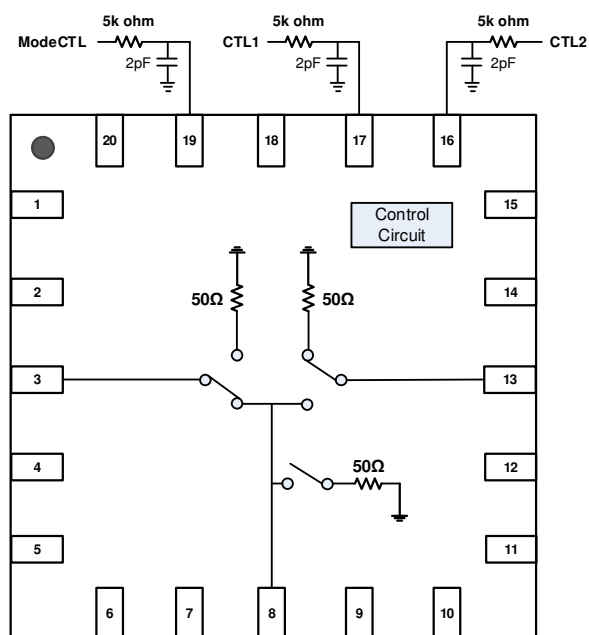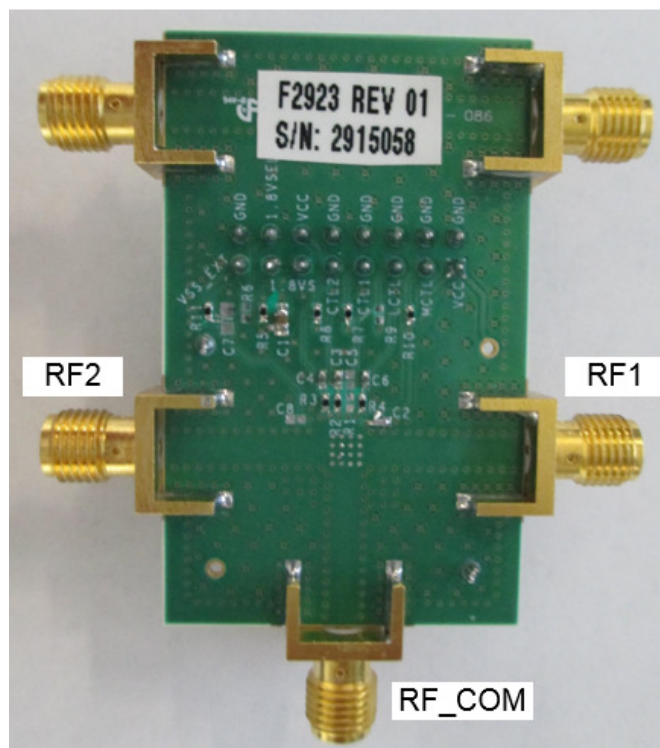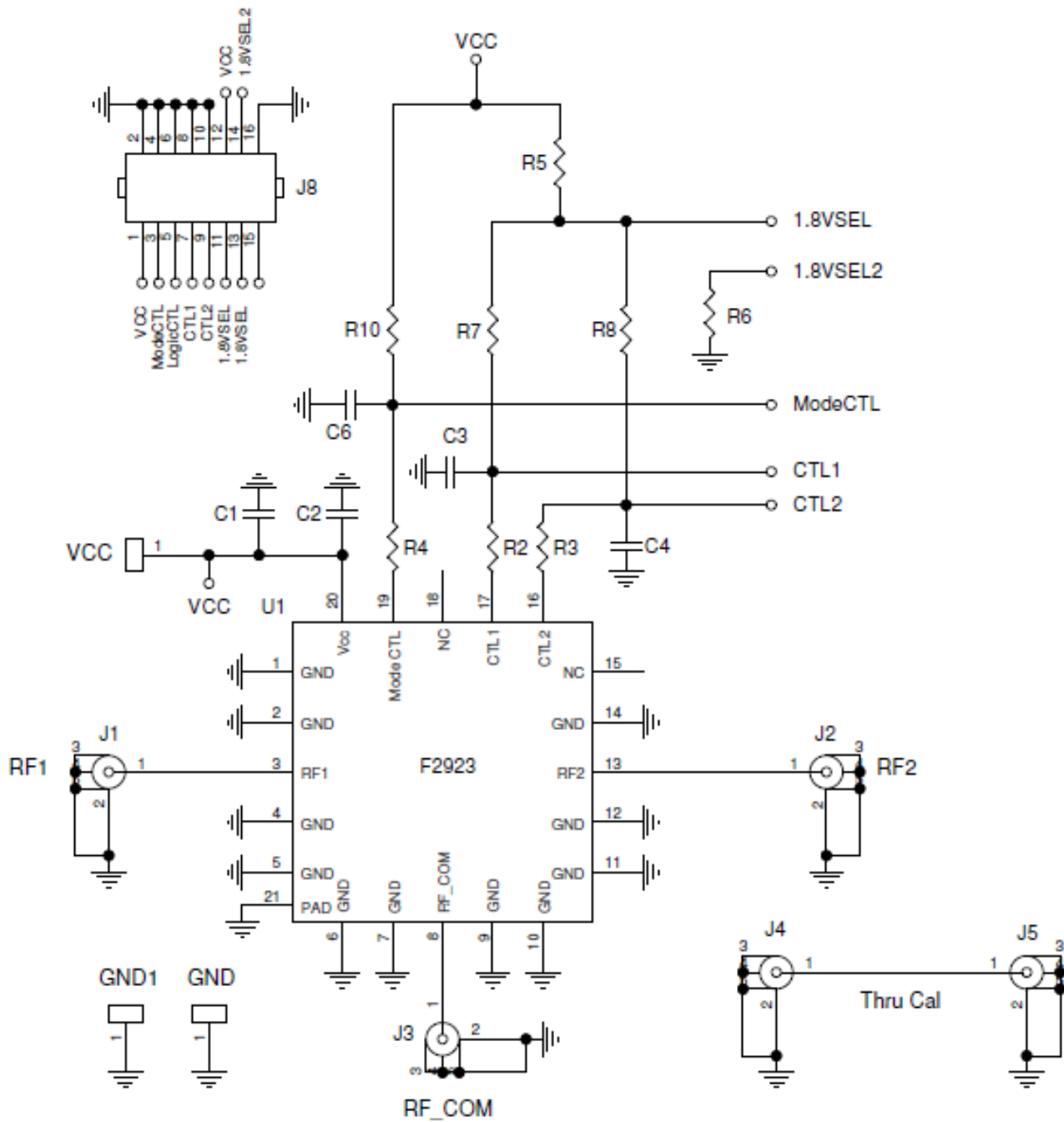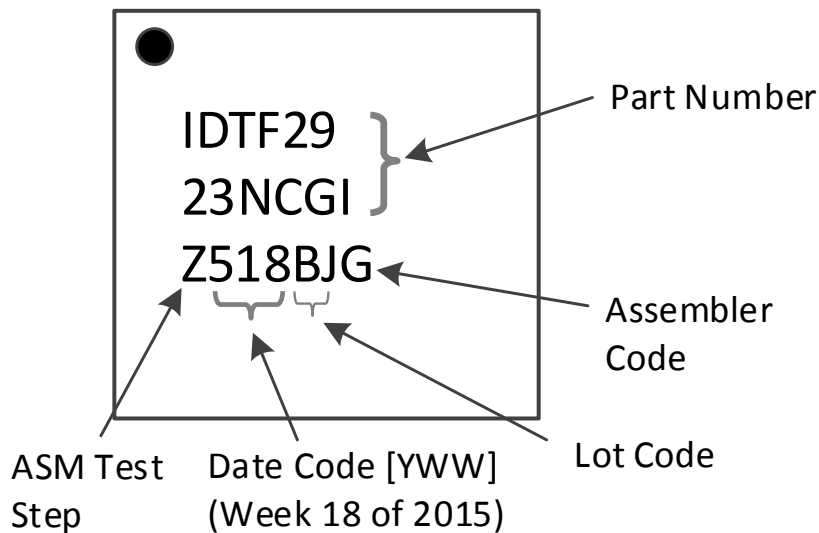
EVKIT PICTURE

Top View
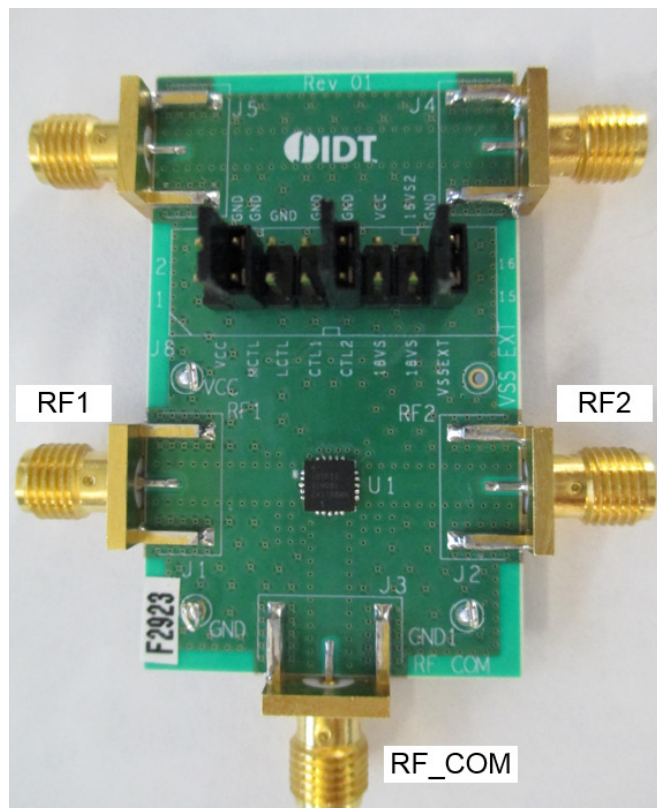
Bottom View

EVKIT / APPLICATIONS CIRCUIT

EVKɪᴛ BOM

Part Reference	QTY	DESCRIPTION	Mfr. Part #	Mfr.
C1	1	100 nF ±10%, 50V, X7R Ceramic Capacitor (0603)	GRM188R71H104K	Murata
C2	1	1000 pF ±5%, 50V, C0G, Ceramic Capacitor (0402)	GRM1555C1H102J	Murata
C3, C4, C6	3	100 pF ±5%, 50V, C0G, Ceramic Capacitor (0402)	GRM1555C1H101J	Murata
R2, R3, R4, R5	4	0 Ω, 1/10W, Resistor (0402)	ERJ-2GE0R00X	Panasonic
R6	0	Not Installed (0402)		
R7, R8, R10	3	100k Ω ±1%, 1/10W, Resistor (0402)	ERJ-2RKF1003X	Panasonic
J1-J5	5	Edge Launch SMA (0.375 inch pitch ground tabs)	142-0701-851	Emerson Johnson
J8	1	CONN HEADER VERT DBL 8 X 2 POS GOLD	67997-116HLF	FCI
VCC, GND, GND1	3	Test Point	5021	Keystone Electronics
U1	1	SP2T Switch 4 mm x 4 mm QFN20-EP	F2923NCGI	IDT
	1	Printed Circuit Board	F2923 EVKIT Rev 01	IDT

Tᴏᴘ Mᴀʀᴋɪɴɢs

IDTF29
23NCGI
Z518BJG

Part Number

Assembler
Code

Lot Code

ASM Test
Step

Date Code [YWW]
(Week 18 of 2015)

EVKIT OPERATION

PCB RF Connectors

The F2923 EVkit is a thin multilayer board (0.032" total thickness) designed using Rogers' 4350 high RF performance material. Since this substrate is not as rigid as standard FR4, one must take care when making connections to the board to avoid physically damaging the board. It is suggested that the body of the connector be restrained while tightening the RF connectors so to not put stress on the PCB material.

External Supply Setup

Set up a VCC power supply in the voltage range of 3.1 V to 3.5 V and disable the power supply output.

Logic Control Setup

Using the EVKIT to manually set the Control Logic:

To setup the part for two pin logic control connect a 2-pin shunt from pin 3 (ModeCTL) to pin 4 (GND) on connector J8.

For one pin logic control leave J8 pin 3 open. An on-board pull-up resistor R10 will connect the ModeCTL pin to Vcc to provide the logic high for one pin control.

The PCB includes 2 pull-up resistors (R7, R8) to Vcc to provide a logic high for CTL1 and CTL2 respectively. Installing a 2-pin shunt from pin 7 (CTL1) to pin 8 (GND) of J8 will provide a logic low for manual control of the CTL1 pin. Placing a 2-pin shunt from pin 9 (CTL2) to pin 10 (GND) of J8 will result in a logic low for the CTL2 pin. See Tables 1, 2 and 3 for control details.

Resistor R6 along with the 1.8VSEL, 1.8VSEL2, and LogicCTL pins are not used on the F2923 EVKIT.

Using External Control Logic:

To setup the part for two pin logic control connect a 2-pin shunt from pin 3 (ModeCTL) to pin 4 (GND) on connector J8.

For one pin control leave pin 3 (ModeCTL) of J8 open. In this configuration the ModeCTL pin will be pulled up to Vcc on the PCB through resistor R10.

Turn on Procedure

Setup the supplies and Eval Board as noted in the **External Supply Setup** and **Logic Control Setup** sections above.

Connect the preset/ disabled VCC power supply to the VCC and GND loops on the PCB.
If controlling CTL1 and CTL2 with external logic then set these to logic low.

Enable the VCC supply.

Set the desired logic setting using CTL1, and CTL2 Table 1 or Table 2 setting. Note that external control logic should not be applied without VCC being applied first.

For manual logic control the J8 connector CTL1 and CTL2 pins can be grounded to a neighboring ground for a logic low or left open for a logic high.

Turn off Procedure

If using external control logic for CTL1, CTL2 then set them to a logic low. Disable the VCC supply.

REVISION HISTORY SHEET

Rev	Date	Page	Description of Change
O	2015-Nov-9		Initial Release

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